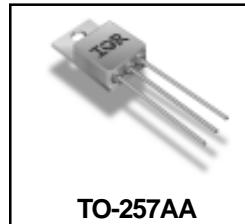


International IR Rectifier

PD - 93824

RADIATION HARDENED POWER MOSFET THRU-HOLE (TO-257AA)

IRHY57Z30CM
30V, N-CHANNEL
R5 TECHNOLOGY



Product Summary

Part Number	Radiation Level	R _{Ds(on)}	I _D
IRHY57Z30CM	100K Rads (Si)	0.020Ω	16A*
IRHY53Z30CM	300K Rads (Si)	0.020Ω	16A*
IRHY54Z30CM	600K Rads (Si)	0.020Ω	16A*
IRHY58Z30CM	1000K Rads (Si)	0.025Ω	16A*

International Rectifier's R5™ technology provides high performance power MOSFETs for space applications. These devices have been characterized for Single Event Effects (SEE) with useful performance up to an LET of 80 (MeV/(mg/cm²)). The combination of low R_{Ds(on)} and low gate charge reduces the power losses in switching applications such as DC to DC converters and motor control. These devices retain all of the well established advantages of MOSFETs such as voltage control, fast switching, ease of paralleling and temperature stability of electrical parameters.

Absolute Maximum Ratings

	Parameter	Units	
I _D @ V _{GS} = 12V, T _C = 25°C	Continuous Drain Current	A	16*
I _D @ V _{GS} = 12V, T _C = 100°C	Continuous Drain Current		16*
I _{DM}	Pulsed Drain Current ①		64
P _D @ T _C = 25°C	Max. Power Dissipation	W	75
	Linear Derating Factor	W/C	0.6
V _{GS}	Gate-to-Source Voltage	V	±20
E _{AS}	Single Pulse Avalanche Energy ②	mJ	194
I _{AR}	Avalanche Current ①	A	16
E _{AR}	Repetitive Avalanche Energy ①	mJ	7.5
dV/dt	Peak Diode Recovery dV/dt ③	V/ns	1.7
T _J	Operating Junction	°C	-55 to 150
T _{TSG}	Storage Temperature Range		
	Lead Temperature		300 (0.063in./1.6mm from case for 10 sec)
	Weight	g	4.3 (Typical)

* Current is limited by internal wire diameter

For footnotes refer to the last page

Features:

- Single Event Effect (SEE) Hardened
- Ultra Low R_{Ds(on)}
- Low Total Gate Charge
- Proton Tolerant
- Simple Drive Requirements
- Ease of Parallelizing
- Hermetically Sealed
- Ceramic Package
- Light Weight

Pre-Irradiation

Radiation Characteristics

IRHY57Z30CM

International Rectifier Radiation Hardened MOSFETs are tested to verify their radiation hardness capability. The hardness assurance program at International Rectifier is comprised of two radiation environments. Every manufacturing lot is tested for total ionizing dose (per notes 5 and 6) using the TO-3 package. Both pre- and post-irradiation performance are tested and specified using the same drive circuitry and test conditions in order to provide a direct comparison.

Table 1. Electrical Characteristics @ $T_j = 25^\circ\text{C}$, Post Total Dose Irradiation^{⑤⑥}

	Parameter	Up to 600K Rads(Si) ¹				Units	Test Conditions
		Min	Max	Min	Max		
BV_{DSS}	Drain-to-Source Breakdown Voltage	30	—	30	—	V	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 1.0\text{mA}$
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage ^④	2.0	4.0	1.5	4.0		$V_{\text{GS}} = V_{\text{DS}}, I_{\text{D}} = 1.0\text{mA}$
I_{GSS}	Gate-to-Source Leakage Forward	—	100	—	100	nA	$V_{\text{GS}} = 20\text{V}$
I_{GSS}	Gate-to-Source Leakage Reverse	—	-100	—	-100		$V_{\text{GS}} = -20\text{V}$
I_{DSS}	Zero Gate Voltage Drain Current	—	10	—	10	μA	$V_{\text{DS}}=24\text{V}, V_{\text{GS}}=0\text{V}$
$R_{\text{DS}(\text{on})}$	Static Drain-to-Source ^④ On-State Resistance (TO-3)	—	0.024	—	0.03	Ω	$V_{\text{GS}} = 12\text{V}, I_{\text{D}} = 16\text{A}$
$R_{\text{DS}(\text{on})}$	Static Drain-to-Source ^④ On-State Resistance (TO-257AA)	—	0.02	—	0.025	Ω	$V_{\text{GS}} = 12\text{V}, I_{\text{D}} = 16\text{A}$
V_{SD}	Diode Forward Voltage ^④	—	1.2	—	1.2	V	$V_{\text{GS}} = 0\text{V}, I_{\text{S}} = 16\text{A}$

1. Part numbers IRHY57Z30CM, IRHY53Z30CM and IRHY54Z30CM

2. Part number IRHY58Z30CM

International Rectifier radiation hardened MOSFETs have been characterized in heavy ion environment for Single Event Effects (SEE). Single Event Effects characterization is illustrated in Fig. a and Table 2.

Table 2. Single Event Effect Safe Operating Area

Ion	LET MeV/(mg/cm ²)	Energy (MeV)	Range (μm)	V_{DS} (V)				
				@ $V_{\text{GS}}=0\text{V}$	@ $V_{\text{GS}}=-5\text{V}$	@ $V_{\text{GS}}=-10\text{V}$	@ $V_{\text{GS}}=-15\text{V}$	@ $V_{\text{GS}}=-20\text{V}$
Br	37.9	255	33.5	30	30	30	25	20
I	59.4	290	28.5	25	25	20	15	10
Au	80.3	313	26.4	22.5	22.5	15	10	—

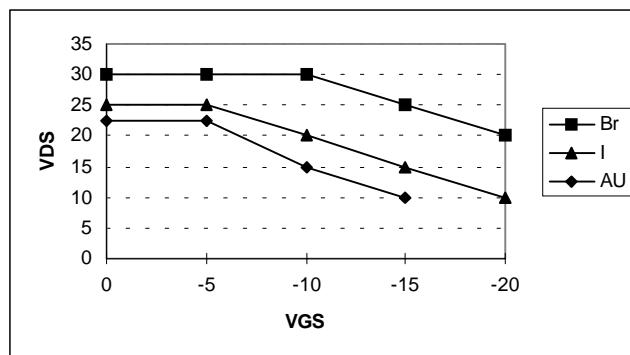


Fig a. Single Event Effect, Safe Operating Area

For footnotes refer to the last page

IRHY57Z30CM

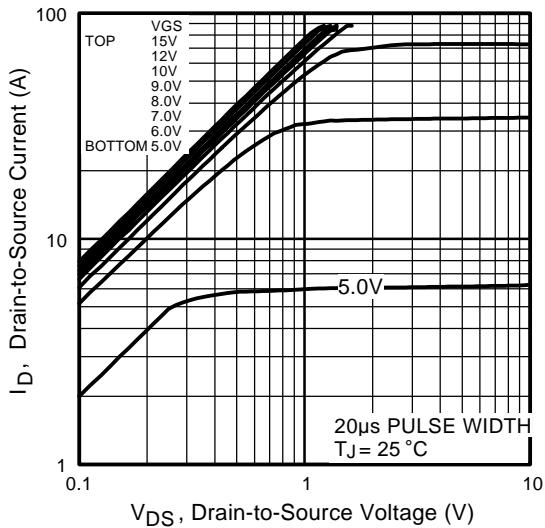


Fig 1. Typical Output Characteristics

Pre-Irradiation

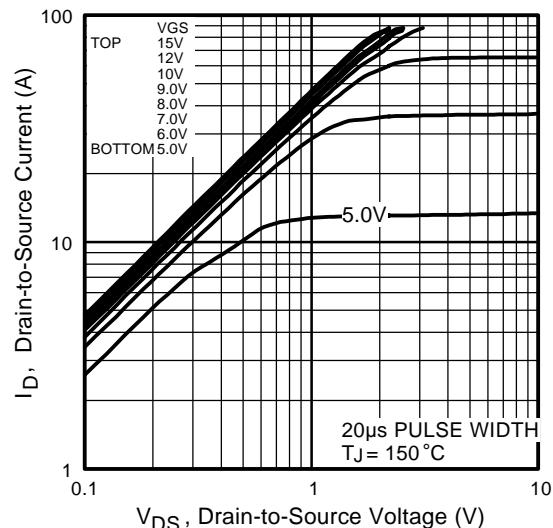


Fig 2. Typical Output Characteristics

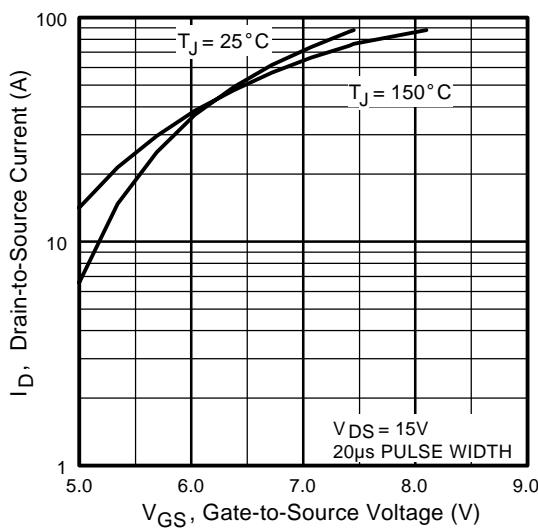


Fig 3. Typical Transfer Characteristics

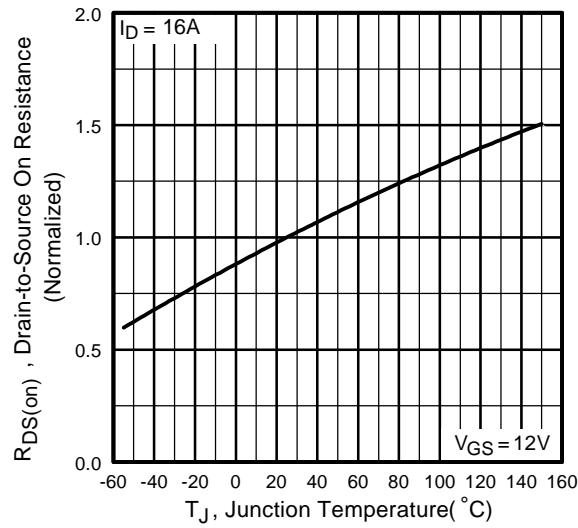


Fig 4. Normalized On-Resistance Vs. Temperature

Pre-Irradiation

IRHY57Z30CM

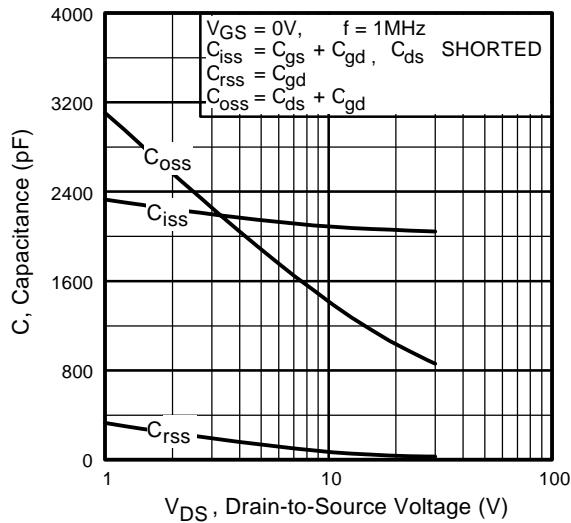


Fig 5. Typical Capacitance Vs.
Drain-to-Source Voltage

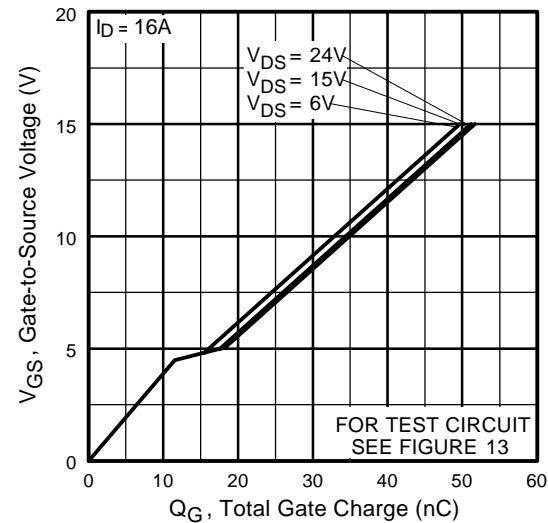


Fig 6. Typical Gate Charge Vs.
Gate-to-Source Voltage

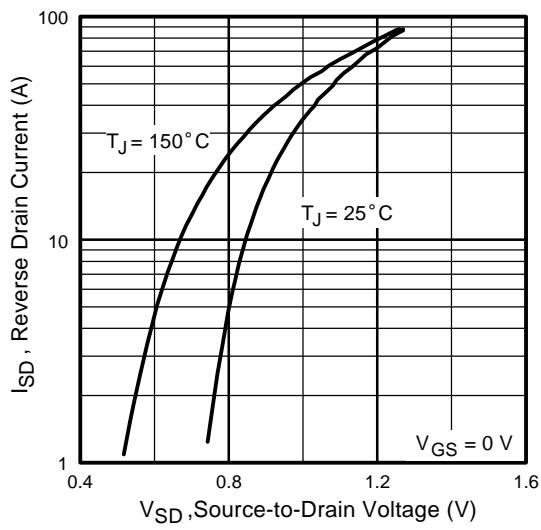


Fig 7. Typical Source-Drain Diode
Forward Voltage

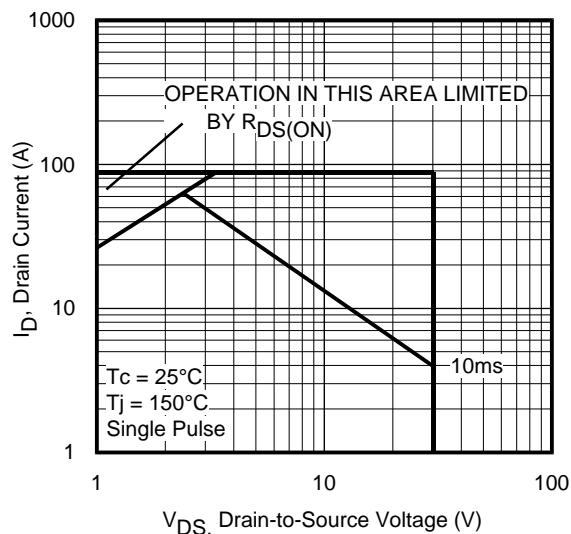


Fig 8. Maximum Safe Operating Area

IRHY57Z30CM

Pre-Irradiation

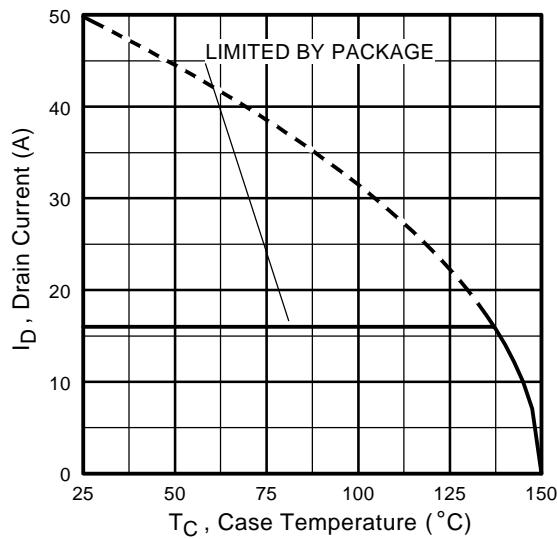


Fig 9. Maximum Drain Current Vs. Case Temperature

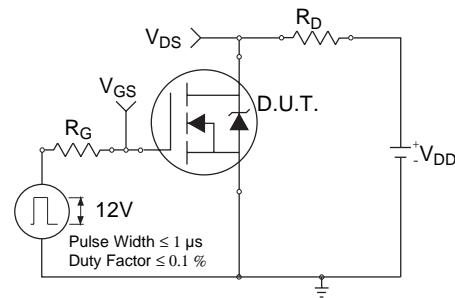


Fig 10a. Switching Time Test Circuit

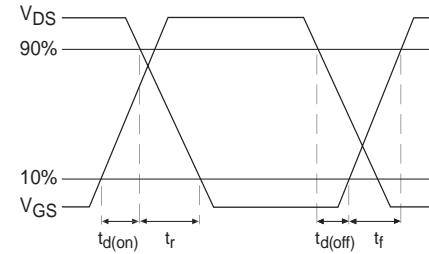


Fig 10b. Switching Time Waveforms

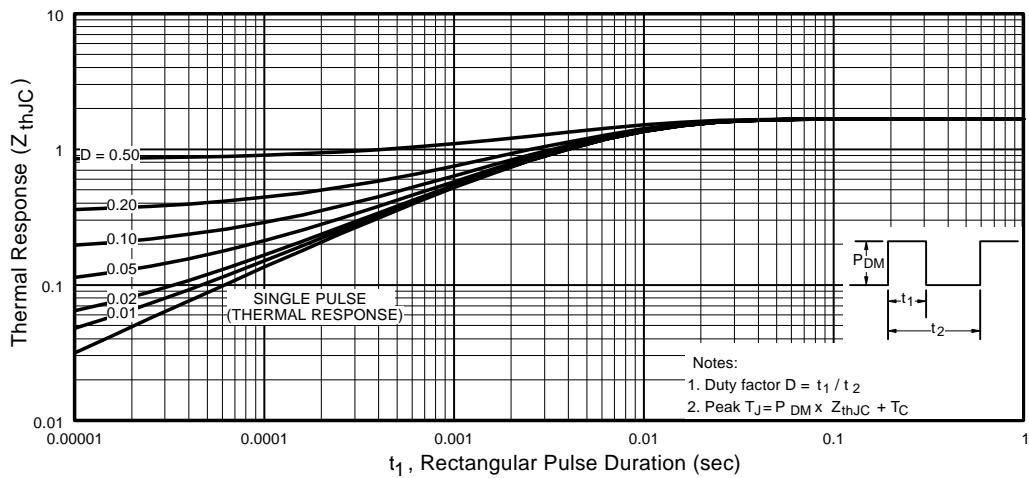


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

Pre-Irradiation

IRHY57Z30CM

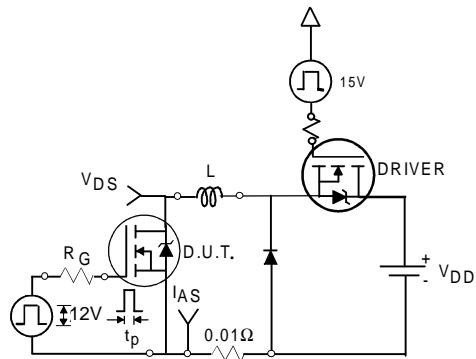


Fig 12a. Unclamped Inductive Test Circuit

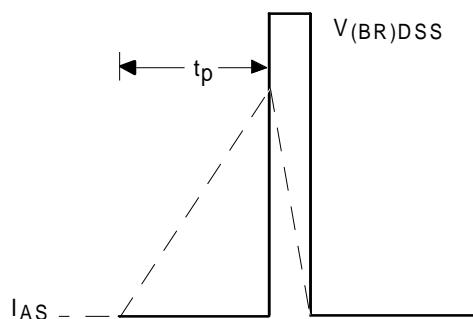


Fig 12b. Unclamped Inductive Waveforms

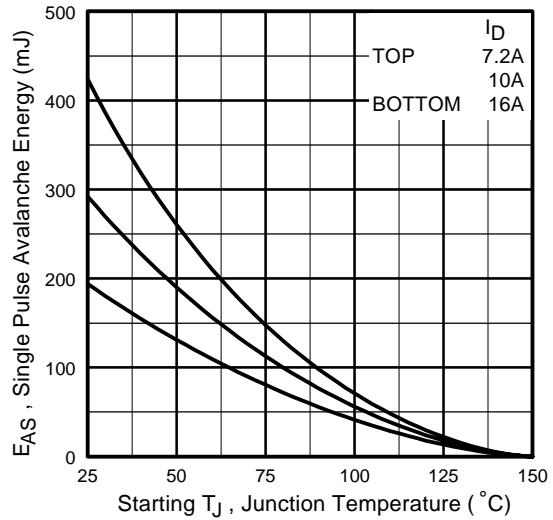


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

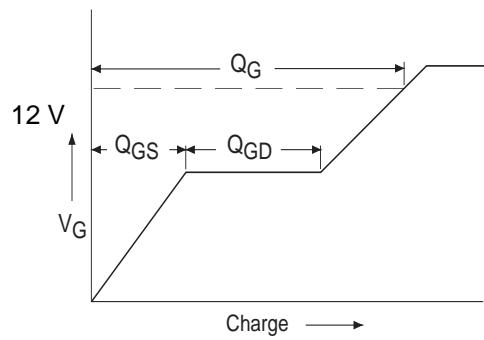


Fig 13a. Basic Gate Charge Waveform

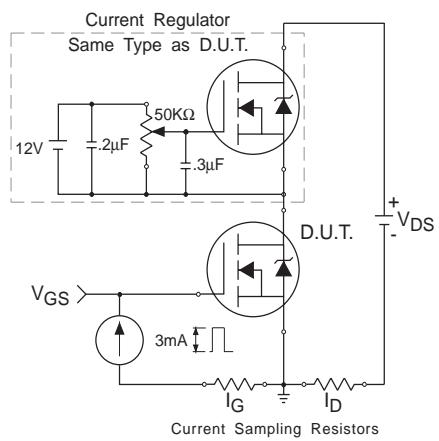
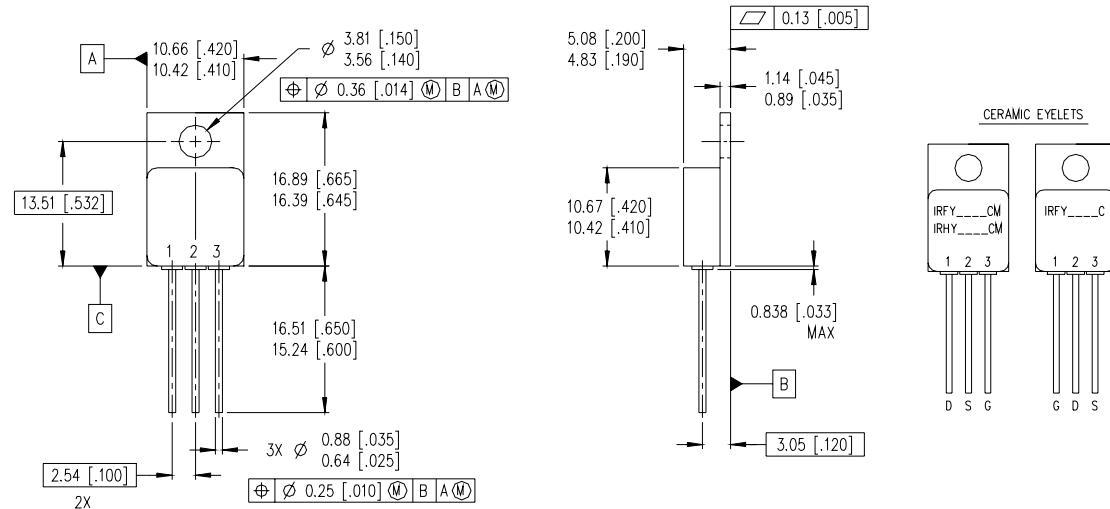


Fig 13b. Gate Charge Test Circuit

Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- ② V_{DD} = 15V, starting T_J = 25°C, L = 1.5 mH
Peak I_L = 16A, V_{GS} = 12V
- ③ ISD ≤ 16A, di/dt ≤ 54A/μs,
V_{DD} ≤ 30V, T_J ≤ 150°C
- ④ Pulse width ≤ 300 μs; Duty Cycle ≤ 2%
- ⑤ **Total Dose Irradiation with V_{GS} Bias.**
12 volt V_{GS} applied and V_{DS} = 0 during irradiation per MIL-STD-750, method 1019, condition A.
- ⑥ **Total Dose Irradiation with V_{DS} Bias.**
24 volt V_{DS} applied and V_{GS} = 0 during irradiation per MIL-STD-750, method 1019, condition A.

Case Outline and Dimensions — TO-257AA**NOTES:**

1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1994.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE TO-257AA.

LEGEND
D - DRAIN
S - SOURCE
G - GATE

International
TOR Rectifier

WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, Tel: (310) 252-7105

IR GREAT BRITAIN: Hurst Green, Oxted, Surrey RH8 9BB, UK Tel: ++ 44 1883 732020

IR CANADA: 15 Lincoln Court, Brampton, Ontario L6T3Z2, Tel: (905) 453 2200

IR GERMANY: Saalburgstrasse 157, 61350 Bad Homburg Tel: ++ 49 6172 96590

IR ITALY: Via Liguria 49, 10071 Borgaro, Torino Tel: ++ 39 11 451 0111

IR JAPAN: K&H Bldg., 2F, 30-4 Nishi-Ikebukuro 3-Chome, Toshima-Ku, Tokyo Japan 171 Tel: 81 3 3983 0086

IR SOUTHEAST ASIA: 1 Kim Seng Promenade, Great World City West Tower, 13-11, Singapore 237994 Tel: ++ 65 838 4630

IR TAIWAN: 16 Fl. Suite D. 207, Sec. 2, Tun Haw South Road, Taipei, 10673, Taiwan Tel: 886-2-2377-9936

Data and specifications subject to change without notice. 1/2000